EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1134	257/510.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/02 09:57
L2	360	257/513.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/02 09:58
L3	29	257/E21.549	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 09:59
L4	34	257/E21.59	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 09:59
L5	18	257/E21.166	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 10:00
L6	58	257/E21.507	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 10:00
L7	26	257/E21.279	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 10:00
L8	171	257/E21.546	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 10:01
L9	43	257/E21.651	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 10:01

L10	47	257/E21.633	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 10:01
L11	1724		US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/02 10:02
L12	143	l11 and (trench with nitride with liner)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/02 10:02
L13	2	l11 and (trench with nitride with edge with bottom)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/02 10:03
L17	0	semiconductor with trench with isolation with substrate with surrounded with sidewall with nitride with second with liner with edge with bottom. clms.	US-PGPUB	OR	ON	2008/09/02 10:37
S1	641	trench with nitride with liner	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/15 16:36
S 2	43	S1 and (stress with reduce)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/19 19:18
S3	22	S1 and (nitride with stress with reduce)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/19 19:19
S4	3	"6518148"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/15 16:51

S 5	17	("20030015736" "5780346" "5811347" "6118168" "6156620" "6261925" "6436790" "6479367" "6498383").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/22 06:58
S 6	2	"6689654"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/06/24 14:14
S7	162	("20010009784" "20020074598" "20020086472" "20020090791" "20030015736" "20030032261" "20030057184" "20030067035" "3602841" "4855245" "4855245" "4855245" "4958213" "5006913" "5060030" "5081513" "5108843" "5134085" "5371399" "5371399" "5371399" "5371399" "5371399" "5371399" "5371399" "5557122" "5557122" "5566697" "5571741" "5592007" "5592018" "5679965" "5679965" "5683934" "5780346" "5780346" "5780346" "5780346" "5811347" "5811347" "5840593"	US-PGPUB; USPAT; EPO; USPAT; EPO; IDERWENT; IBM_TDB	OR	OFF	2005/02/19 19:17

S8	727	trench with nitride with liner	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/19 19:18
S8	727			OR	OFF	
		"5861651" "5880040" "5940736" "5946559"				

S9	51	S8 and (stress with reduce)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/19 19:18
S10	28	S8 and (nitride with stress with reduce)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/19 19:19
S11	3	"6544855"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 19:54
S12	44	S7 and (nitride with trench)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 19:54
S13	0	S12 and NFET and PFET	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 19:55
S14	0	S7 and NFET and PFET	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/07 01:48
S15	3	S12 and FET	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 19:55
S16	11	S8 and NFET and PFET	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 20:19
S17	0	S8 and (nitride with 2nm)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 20:19
S18	1	S8 and (nitride with ("2.0" adj nm))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 20:20

S19	4	S8 and (nitride with ("1.0" adj nm))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/19 20:21
S20	448	(nitride with liner with trench) and plasma	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 17:44
S21	382	(nitride with liner with trench) and plasma and (trench with isolation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 17:47
S22	19	(nitride with liner with trench) and (plasma with nitridation) and (trench with isolation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 14:19
S 23	2	S22 and penetrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 17:48
S24	22	(nitride with liner with trench) and (plasma with nitridation) and (trench with isolation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 14:20
S 25	832	257/510.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/22 06:59
S 26	31	"5940717"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 14:59
S27	36	trench with (filler or filled) with oxide with nitrogen	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/05 17:01
S28	3	"6887798"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/05 17:00

S29	1	"20020177270".PN.	US-PGPUB	OR	ON	2007/07/22 15:04
S30	1	"6486039".PN.	USPAT; USOCR	OR	ON	2007/07/22 15:04
S31	1	"6479367".PN.	USPAT; USOCR	OR	ON	2007/07/22 15:05
S32	1	"6156620".PN.	USPAT; USOCR	OR	ON	2007/07/22 15:05
S33	83	("20020031890" "20020076899" "20020153549" "20020190284" "20030001219" "20030030091" "20030080386" "20040026765" "4314269" "4631803" "4946799" "5447884" "5461250" "5534713" "5629544" "5714777" "5763315" "5763315" "5811857" "6008095" "6015993" "6046487" "6022234" "6232163" "6232163" "6232163" "6258664" "6291321" "6294834" "6358791" "63587739" "6413802" "6413802" "6413802" "6429061" "6448114" "6475838" "6429061" "64555839" "6555839" "65558998" "6653700" "6657276" "0621131").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	NOR	ON	2008/01/01

S34	33	S33 and nitride	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/01 15:19
S 35	23	S34 and (trench with (isolation or insulator))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/01 15:20
S36	9	S35 and stress	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/01 15:21
S 37	6	S36 and sidewall	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/01 15:21
S38	0	S37 and birdsbeak	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/01 15:22
S39	1	S37 and (bird\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/01 15:22
S40	7	"6657256"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/07 01:32
S41	11	"6882025"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/07 01:33
S42	1	"6657276".PN.	USPAT; USOCR	OR	ON	2008/01/07 01:34
S43	1	"20020031890".PN.	US-PGPUB	OR	ON	2008/01/07 01:34

54	83	("20020031890" "20020076899" "20020153549" "20020190284" "20030001219" "20030030091" "20030080386" "20040026765" "4314269" "4631803" "4946799" "5447884" "5461250" "5534713" "5629544" "5714777" "5763315" "5811857" "6008095" "6015993" "6046487" "6022234" "6232163" "6232163" "6232163" "6258664" "6291321" "6294834" "6358791" "6387739" "6413802" "6413802" "6429061" "6448114" "6475838" "6429061" "6475838" "6555839" "6555839" "6555839" "6555839" "6657276" "0621131").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB		ON	2008/01/07 01:41
S45	33	S44 and nitride	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/07 01:41
S46	23	S45 and (trench with (isolation or insulator))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/07 01:41

S47	9	S46 and stress	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/07 01:41
S48	14	(US-20030077872-\$ or US-20020155730-\$ or US-20040212035-\$ or US-20040155275-\$). did. or (US-6348394-\$ or US-6887798-\$ or US-5940717-\$ or US-6518148-\$ or US-6644855-\$ or US-6689654-\$ or US-6657256-\$ or US-6682025-\$).did.	US-PGPUB; USPAT	OR	ON	2008/01/07 01:41
S49	8	S48 and stress	US-PGPUB; USPAT	OR	ON	2008/01/07 01:42
S50	8	S48 and stress and nitride	US-PGPUB; USPAT	OR	ON	2008/01/07 01:42
S51	1445	trench with nitride with liner	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/07 01:50
S52	57	S51 and (nitride with stress with reduce)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/07 01:48
S53	8	S52 and NFET and PFET	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/07 01:49
S 54	0	trench with nitride with liner with compression with stress	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/07 01:50
S 55	4	trench with nitride with compression with stress	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/07 01:51

S56	15	(US-20030077872-\$ or US-20040212035-\$ or US-20040155275-\$ or US-20020155730-\$ or US-20050121727-\$). did. or (US-6156620-\$ or US-6689654-\$ or US-6544855-\$ or US-6348394-\$ or US-6887798-\$ or US-6882025-\$ or US-5940717-\$ or US-6657256-\$).did.	US-PGPUB; USPAT	OR	ON	2008/06/23 08:06
S57	2	S56 and (nitride with stress with compressive)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/23 08:07
S58	9	S56 and (nitride with stress)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/23 08:08
S 59	73	"6090684"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/23 08:23

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